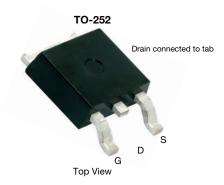


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Automotive N-Channel 250 V (D-S) 175 °C MOSFET

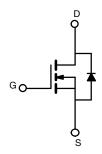


PRODUCT SUMMARY					
V _{DS} (V)	250				
$R_{DS(on)}$ (Ω) at $V_{GS} = 10 \text{ V}$	0.1620				
$R_{DS(on)}$ (Ω) at $V_{GS} = 7.5 \text{ V}$	0.1800				
I _D (A)	11.5				
Configuration	Single				
Package	TO-252				

FEATURES

- TrenchFET® power MOSFET
- Package with low thermal resistance
- 100 % R_q and UIS tested
- AEC-Q101 qualified
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>





N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)					
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V_{DS}	250	V	
Gate-source voltage		V_{GS}	± 20	V	
Continuous drain current	T _C = 25 °C	I-	11.5		
	T _C = 125 °C	- I _D	6.6		
Continuous source current (diode conduction)	Is	50	Α		
Pulsed drain current ^b	I _{DM}	30			
Single pulse avalanche current	L = 0.1 mH	I _{AS}	10		
Single pulse avalanche energy	L = 0.1 IIIII	E _{AS}	5	mJ	
Maximum power dissipation ^b	T _C = 25 °C	P _D	62	W	
	T _C = 125 °C] ' ⁻ D	20	v V	
Operating junction and storage temperature ran	nge	T _J , T _{stg}	-55 to +175	°C	

THERMAL RESISTANCE RATINGS						
PARAMETER		SYMBOL	LIMIT	UNIT		
Junction-to-ambient	PCB mount c	R_{thJA}	50	°C/W		
Junction-to-case (drain)		R_{thJC}	2.4	C/VV		

Notes

- a. Package limited
- b. Pulse test; pulse width $\leq 300~\mu s,~duty~cycle \leq 2~\%$
- c. When mounted on 1" square PCB (FR4 material)



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PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static							
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		250	-	-	V
Gate-source threshold voltage	V _{GS(th)}	V _{DS} =	· V _{GS} , I _D = 250 μA	2.5	3.0	3.5	V
Gate-source leakage	I _{GSS}	V _{DS} =	$0 \text{ V}, \text{ V}_{GS} = \pm 20 \text{ V}$	-	-	± 100	nA
	I _{DSS}	$V_{GS} = 0 V$	V _{DS} = 250 V	-	-	1	μА
Zero gate voltage drain current		V _{GS} = 0 V	V _{DS} = 250 V, T _J = 125 °C	-	-	50	
		V _{GS} = 0 V	V _{DS} = 250 V, T _J = 175 °C	-	-	250	μΑ
On-state drain current ^a	I _{D(on)}	V _{GS} = 10 V	$V_{DS} \ge 5 V$	12	-	-	Α
	• •	V _{GS} = 10 V	I _D = 12 A	-	0.1342	0.1620	Ω
During and a solution of the s	Б	V _{GS} = 7.5 V	I _D = 10 A	-	0.1443	0.1800	
Drain-source on-state resistance a	R _{DS(on)}	V _{GS} = 10 V	I _D = 12 A, T _J = 125 °C	-	-	0.3437	
		V _{GS} = 10 V	I _D = 12 A, T _J = 175 °C	=	-	0.4560	
Forward transconductance b	9 _{fs}	V _{DS} = 15 V, I _D = 12 A		=	12	-	S
Dynamic ^b		•			·	ı	ı
Input capacitance	C _{iss}		V _{DS} = 25 V, f = 1 MHz	-	558	785	pF
Output capacitance	C _{oss}	$V_{GS} = 0 V$		-	308	435	
Reverse transfer capacitance	C _{rss}	1		=	11	16	
Total gate charge ^c	Qq				10.6	16	
Gate-source charge c	Q _{gs}	V _{GS} = 10 V	$V_{DS} = 125 \text{ V}, I_{D} = 10 \text{ A}$	-	3.1	-	nC
Gate-drain charge ^c	Q _{qd}	1		=	2.8	-	
Gate resistance	R _q	f = 1 MHz		1.9	3.8	5.7	Ω
Turn-on delay time c	t _{d(on)}	V_{DD} = 125 V, R_L = 12.5 Ω I_D \cong 10 A, V_{GEN} = 10 V, R_g = 1 Ω		=	8	20	
Rise time ^c	t _r			=.	3	10	
Turn-off delay time ^c	t _{d(off)}			=	15	30	- ns
Fall time c	t _f			=	3	10	
Source-Drain Diode Ratings and Charac	cteristics b						1
Pulsed current a	I _{SM}			-	-	30	Α
Forward voltage	V _{SD}	I _F = 15 A, V _{GS} = 0 V		-	0.9	1.5	V
Body diode reverse recovery time	t _{rr}	I _F = 10 A, di/dt = 100 A/μs		-	127	260	ns
Body diode reverse recovery charge	Q _{rr}			-	583	1170	nC
Reverse recovery fall time	t _a			-	88	-	
Reverse recovery rise time	t _b			_	39	-	ns
Body diode peak reverse recovery current	I _{RM(REC)}			_	-8.6	_	Α

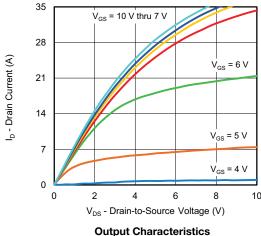
Notes

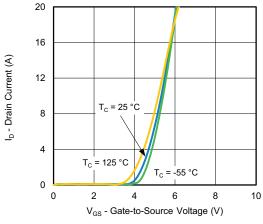
- a. Pulse test; pulse width $\leq 300~\mu s,~duty~cycle \leq 2~\%$
- b. Guaranteed by design, not subject to production testing
- c. Independent of operating temperature

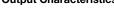
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



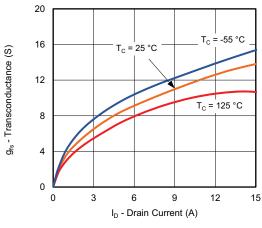
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)

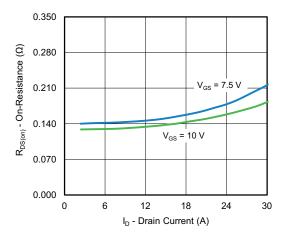






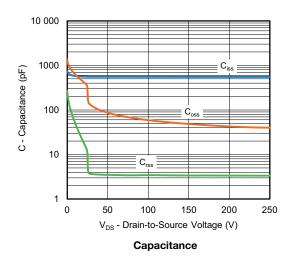


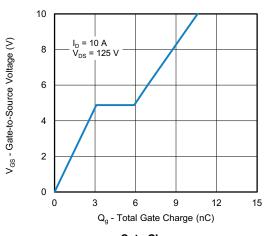




Transconductance

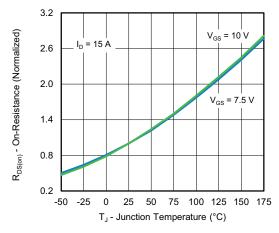
On-Resistance vs. Drain Current



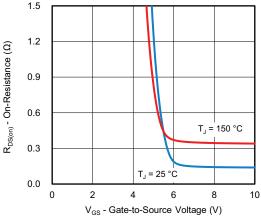




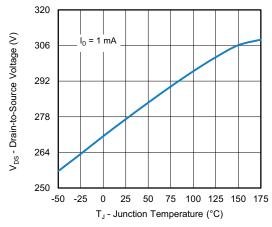
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



On-Resistance vs. Junction Temperature



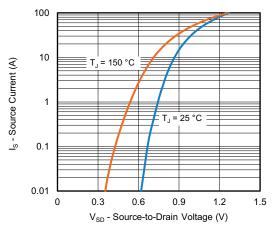
On-Resistance vs. Gate-to-Source Voltage



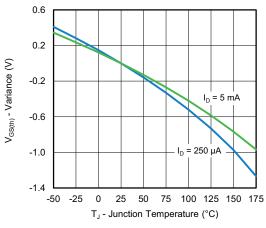
Drain Source Breakdown vs. Junction Temperature

Note

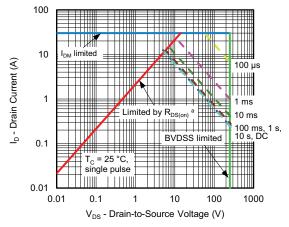
a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified



Source Drain Diode Forward Voltage



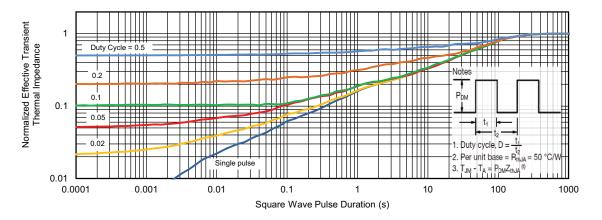
Threshold Voltage



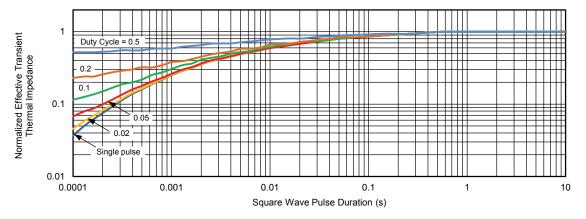
Safe Operating Area



THERMAL RATINGS (T_A = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

Note

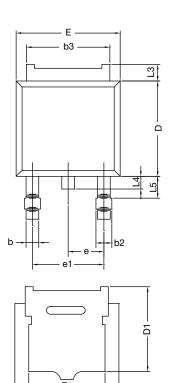
- The characteristics shown in the two graphs
 - Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)
 - Normalized Transient Thermal Impedance Junction-to-Case (25 °C) are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions

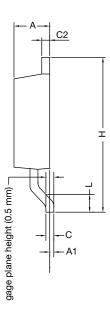
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TO-252AA Case Outline





	MILLIN	METERS	INC	HES	
DIM.	MIN.	MAX.	MIN.	MAX.	
Α	2.18	2.38	0.086	0.094	
A1	-	0.127	-	0.005	
b	0.64	0.88	0.025	0.035	
b2	0.76	1.14	0.030	0.045	
b3	4.95	5.46	0.195	0.215	
С	0.46	0.61	0.018	0.024	
C2	0.46	0.89	0.018	0.035	
D	5.97	6.22	0.235	0.245	
D1	4.10	-	0.161	-	
Е	6.35	6.73	0.250	0.265	
E1	4.32	-	0.170	-	
Н	9.40	10.41	0.370	0.410	
е	2.28	BSC	0.090	BSC	
e1	4.56 BSC		0.180 BSC		
L	1.40	1.78	0.055	0.070	
L3	0.89	1.27	0.035	0.050	
L4	-	1.02	-	0.040	
L5	1.01	1.52	0.040	0.060	
ECN: T13-0592-Rev. A, 02-Sep-13					

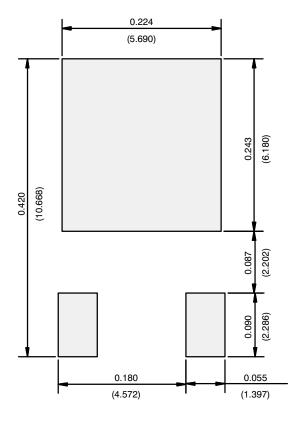
DWG: 6019

Note

• Dimension L3 is for reference only.



RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)

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APPLICATION NOTE



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